

### NCE N-Channel Enhancement Mode Power MOSFET

#### **Description**

The NCE60H10D uses advanced trench technology and design to provide excellent  $R_{\rm DS(ON)}$  with low gate charge. This device is suitable for use in PWM, load switching and general purpose applications.

#### **General Features**

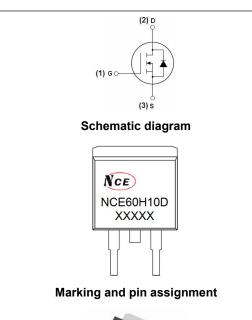
- $V_{DS}$  =60V, $I_{D}$  =100A  $R_{DS(ON)}$  < 5.2mΩ @  $V_{GS}$ =10V (Typ:4.5mΩ)
- High density cell design for ultra low Rdson
- Fully characterized avalanche voltage and current
- Special designed for convertors and power controls
- Good stability and uniformity with high E<sub>AS</sub>
- Excellent package for good heat dissipation
- Special process technology for high ESD capability

#### **Application**

- Power switching application
- Hard switched and High frequency circuits
- Uninterruptible power supply

100% UIS TESTED!

100% ΔVds TESTED!





TO-263-2L top view

#### **Package Marking and Ordering Information**

| Device Marking | Device    | Device Package | Reel Size | Tape width | Quantity |
|----------------|-----------|----------------|-----------|------------|----------|
| NCE60H10D      | NCE60H10D | TO-263-2L      | -         | -          | -        |

### Absolute Maximum Ratings (T<sub>4</sub>=25℃unless otherwise noted)

| Parameter  | Symbol                           | Limit      | Unit |  |
|--|----------------------------------|------------|------|--|
| Drain-Source Voltage                             | V <sub>DS</sub>                  | 60         | V    |  |
| Gate-Source Voltage                              | V <sub>G</sub> s                 | ±20        | V    |  |
| Drain Current-Continuous                         | I <sub>D</sub>                   | 100        | А    |  |
| Drain Current-Continuous(Tc=100 ℃)               | I <sub>D</sub> (100℃)            | 70         | А    |  |
| Pulsed Drain Current                             | I <sub>DM</sub>                  | 320        | А    |  |
| Maximum Power Dissipation <sup>(Note 1)</sup>    | P <sub>D</sub>                   | 170        | W    |  |
| Derating factor                                  |                                  | 1.13       | W/°C |  |
| Single pulse avalanche energy (Note 5)           | E <sub>AS</sub>                  | 812        | mJ   |  |
| Operating Junction and Storage Temperature Range | T <sub>J</sub> ,T <sub>STG</sub> | -55 To 175 | °C   |  |

#### **Thermal Characteristic**

| Thermal Resistance,Junction-to-Case <sup>(Note 2)</sup> | R <sub>θJC</sub> | 0.88 | °C/W |
|---|------------------|------|------|
|---|------------------|------|------|

## Electrical Characteristics (T<sub>A</sub>=25 ℃ unless otherwise noted)

| Parameter                          | Symbol              | Condition                                 | Min          | Тур        | Max        | Unit     |
|------------------------------------|---------------------|---|--------------|------------|------------|----------|
| Off Characteristics                |                     |   |              |            |            |          |
| Drain-Source Breakdown Voltage     | BV <sub>DSS</sub>   | V <sub>GS</sub> =0V I <sub>D</sub> =250µA | 60           | -          | -          | V        |
| Zero Gate Voltage Drain Current    | I <sub>DSS</sub>    | V <sub>DS</sub> =60V,V <sub>GS</sub> =0V  | -            | -          | 1          | μA       |
| Gate-Body Leakage Current          | I <sub>GSS</sub>    | V <sub>GS</sub> =±20V,V <sub>DS</sub> =0V | -            | -          | ±100       | nA       |
| On Characteristics (Note 3)        |                     |   |              |            |            |          |
| Gate Threshold Voltage             | V <sub>GS(th)</sub> | $V_{DS}=V_{GS},I_{D}=250\mu A$            | 2            | 3          | 4          | V        |
| Drain-Source On-State Resistance   | R <sub>DS(ON)</sub> | V <sub>GS</sub> =10V, I <sub>D</sub> =20A | -            | 4.5        | 5.2        | mΩ       |
| Forward Transconductance           | <b>G</b> FS         | V <sub>DS</sub> =5V,I <sub>D</sub> =20A   | -            | 50         | -          | S        |
| Dynamic Characteristics (Note4)    |                     |   |              |            |            |          |
| Input Capacitance                  | C <sub>lss</sub>    | V <sub>DS</sub> =30V,V <sub>GS</sub> =0V, | -            | 5200       | -          | PF       |
| Output Capacitance                 | Coss                |   | -            | 410        | -          | μΑ  00   |
| Reverse Transfer Capacitance       | C <sub>rss</sub>    | F=1.0MHz - 330 -                          |              | -          | PF         |          |
| Switching Characteristics (Note 4) |                     |   |              |            |            |          |
| Turn-on Delay Time                 | t <sub>d(on)</sub>  |   | -            | 17         | -          | nS       |
| Turn-on Rise Time                  | t <sub>r</sub>      | VDD=30V,RL=1.5Ω                           | -            | 11         | -          | nS       |
| Turn-Off Delay Time                | t <sub>d(off)</sub> | RG=2.5Ω,VGS=10V                           | -            | 55         | -          | nS       |
| Turn-Off Fall Time                 | t <sub>f</sub>      |   | -            | 15         | -          | nS       |
| Total Gate Charge                  | Qg                  | V 20VI 20A                                | -            | 100        | -          | nC       |
| Gate-Source Charge                 | Q <sub>gs</sub>     | $V_{DS}=30V,I_{D}=20A,$<br>$V_{GS}=10V$   | -            | 21         | -          | nC       |
| Gate-Drain Charge                  | $Q_{\mathrm{gd}}$   | V <sub>GS</sub> -1UV                      | -            | 30         | -          | nC       |
| Drain-Source Diode Characteristics | ·                   |   |              | •          |            |          |
| Diode Forward Voltage (Note 3)     | V <sub>SD</sub>     | V <sub>GS</sub> =0V,I <sub>S</sub> =20A   | -            | -          | 1.2        | V        |
| Diode Forward Current (Note 2)     | Is                  |   | -            | -          | 100        | Α        |
| Reverse Recovery Time              | t <sub>rr</sub>     | Tj=25℃,I <sub>F</sub> =100A               | -            |            | 37         | nS       |
| Reverse Recovery Charge            | Qrr                 | di/dt=100A/µs <sup>(Note3)</sup>          | -            |            | 58         | nC       |
| Forward Turn-On Time               | t <sub>on</sub>     | Intrinsic turn-on time is neg             | ligible (tur | n-on is do | ominated b | y LS+LD) |
|                                    |                     |   |              |            |            |          |

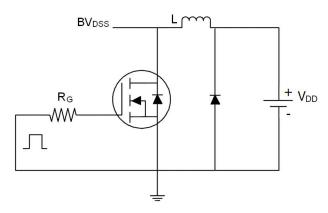
#### Notes:

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 2. Surface Mounted on FR4 Board, t ≤ 10 sec.
- **3.** Pulse Test: Pulse Width ≤  $300\mu$ s, Duty Cycle ≤ 2%.
- 4. Guaranteed by design, not subject to production
- **5.** EAS condition: Tj=25 $^{\circ}$ C,VDD=35V,VG=10V,L=0.5mH,Rg=25 $\Omega$

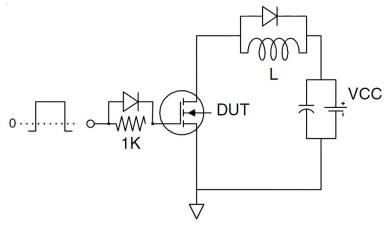


# **Test Circuit**

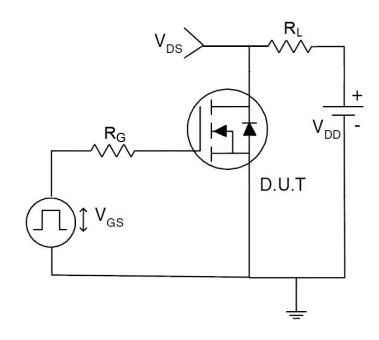
## 1) E<sub>AS</sub> Test Circuits



### 2) Gate Charge Test Circuit

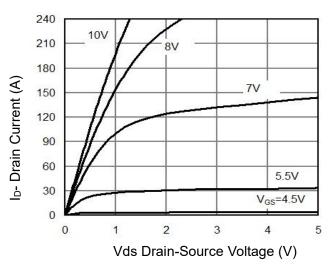


### 3) Switch Time Test Circuit

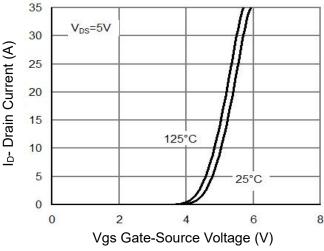




### **Typical Electrical and Thermal Characteristics (Curves)**



**Figure 1 Output Characteristics** 



**Figure 2 Transfer Characteristics** 

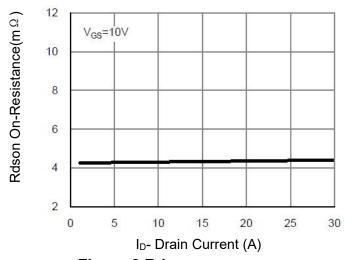


Figure 3 Rdson- Drain Current

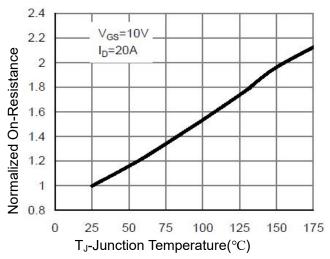


Figure 4 Rdson-Junction Temperature

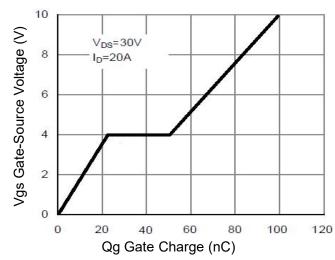


Figure 5 Gate Charge

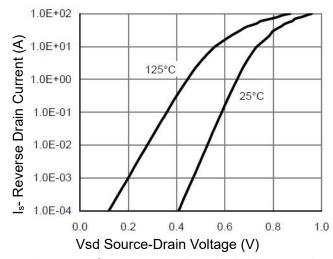


Figure 6 Source- Drain Diode Forward



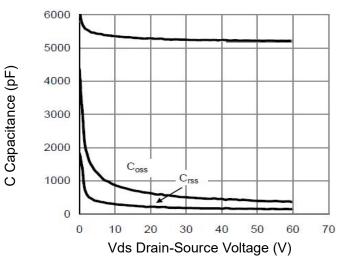


Figure 7 Capacitance vs Vds

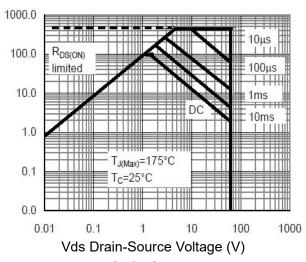


Figure 8 Safe Operation Area

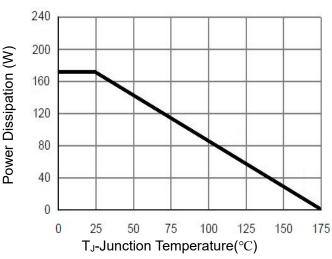


Figure 9 Power De-rating

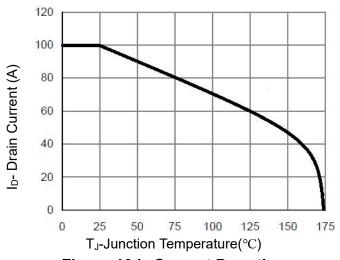
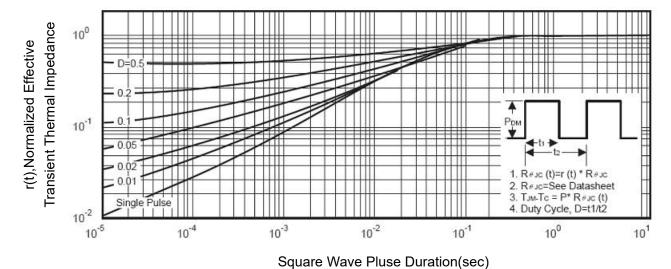


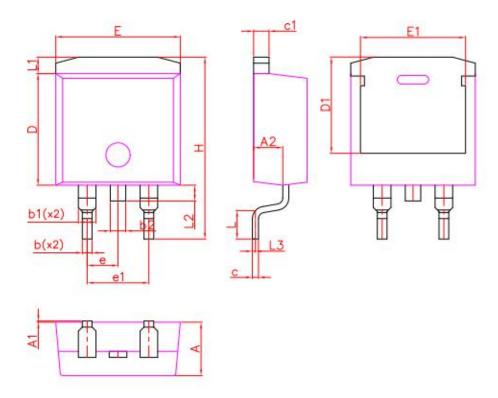
Figure 10 ID Current De-rating



**Figure 11 Normalized Maximum Transient Thermal Impedance** 



# **TO-263-2L Package Information**



| DIM I |         | 263   | MAY   |  |
|-------|---------|-------|-------|--|
| DIM.  | MIN.    | NOM.  | MAX.  |  |
| Α     | 4.20    | 4.40  | 4.60  |  |
| A1    | 0.00    | 0.10  | 0.25  |  |
| A2    | 2.20    | 2.40  | 2.60  |  |
| b     | 0.70    | 0.80  | 0.90  |  |
| ь1    | 1.20    | 1.45  | 1.75  |  |
| b2    | 1.17    | 1.27  | 1.37  |  |
| С     | 0.40    | 0.50  | 0.60  |  |
| c1    | 1.15    | 1.27  | 1.40  |  |
| D     | 9.10    | 9.20  | 9.30  |  |
| D1    | 7.63    | 7.93  | 8.23  |  |
| E     | 10.05   | 10.25 | 10.45 |  |
| E1    | 8.35    | 8.65  | 8.95  |  |
| е     | 2.54BSC |       |       |  |
| e1    | 5.08BSC |       |       |  |
| Н     | 14.61   | 15.00 | 15.88 |  |
| L     | 1.78    | 2.35  | 2.79  |  |
| L1    | 1.36REF |       |       |  |
| L2    | 1.3REF  |       |       |  |
| L3    | 0.25REF |       |       |  |

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